

SEMICON® JAPAN

Dates 12/17 (Wed) to 19 (Fri) Time 10:00 to 17:00

Venue Tokyo Big Sight CKD Booth South 1-Hall S1505

Fine System Equipment Supporting the Semiconductor Market





Since the 1980s, we have contributed to higher precision and improved yields in semiconductor manufacturing processes through our "Accumulated technological capabilities," "Commitment to integrated production of core components," and "Thorough manufacturing process management."

Improving Productivity

Direct Acting 3-Port Valve, 3QR Series

For High-Speed Dispensing and Sorting

3QR High-Response Specification

Industry-Leading Level

Response Time ON: 2±0.5 ms (Initial value based on JIS B 8419: 2010 dynamic

performance test)







For Battery-driven and Continuous **Energization Applications**

3QR Free power supply spec type

Industry First Free power solenoid For preventing valve malfunction

With interlock function MN3/4E0/MN3/4E00 Series

Implements an interlock function through individual power supply and shut-off

High speed 3D inspection equipment for advanced packaging

[Measurement Examples] Micro bump height, Cu pillars, wafer/substrate warpage, foreign matter



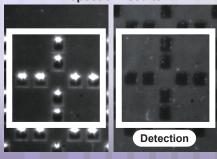
- · High-speed measurement using CKD's proprietary (patented) optical system: 32 WPH
- High resolution: Horizontal resolution 1 µm
- Compatible standards: SEMI S2, S8, CE

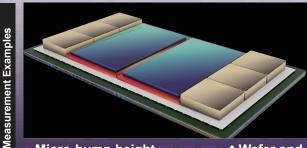
New Transparent Object Inspection System

[Measurement Examples] Flux inspection, TGV inspection



Inspection results





- Micro-bump height
- Cu Pillar

- Wafer and substrate Distortion
- Foreign matter

TGV Inspection



From front-end to mid- and back-end semiconductor processes, you will find hints to solve your challenges with CKD's total technical capabilities. Please feel free to visit our booth.





